XP161A1355PR-G

Power MOSFET

■GENERAL DESCRIPTION

The XP161A1355PR-G is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

A gate protect diode is built-in to prevent static damage.

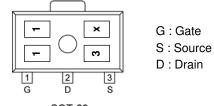
The small SOT-89 package makes high density mounting possible.

APPLICATIONS

Notebook PCs

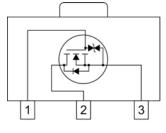
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

PIN CONFIGURATION/ MARKING



SOT-89 (TOP VIEW) * x represents production lot number.

■EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

FEATURES

Low On-State Resistance : Rds (on)= 0.05Ω @ Vgs = 4.5V : Rds (on)= 0.07Ω @ Vgs = 2.5V : Rds (on)= 0.15Ω @ Vgs = 1.5V

Ultra High-Speed Switching Gate Protect Diode Built-in Driving Voltage : 1.5V N-Channel Power MOSFET DMOS Structure Small Package : SOT-89 Environmentally Friendly : EU RoHS Compliant, Pb Free

■PRODUCT NAME

PRODUCT NAME	PACKAGE	ORDER UNIT
XP161A1355PR	SOT-89	1,000/Reel
XP161A1355PR-G ^(*)	SOT-89	1,000/Reel

^(*) The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

■ ABSOLUTE MAXIMUM RATINGS

	la = 25 (
PARAMETER	SYMBOL	RATINGS	UNITS		
Drain-Source Voltage	Vdss	20	V		
Gate-Source Voltage	Vgss	±8	V		
Drain Current (DC)	ld	4	А		
Drain Current (Pulse)	ldp	16	А		
Reverse Drain Current	ldr	4	А		
Channel Power Dissipation *	Pd	2	W		
Channel Temperature	Tch	150	°C		
Storage Temperature	Tstg	-55~150	°C		

* When implemented on a ceramic PCB

■ ELECTRICAL CHARACTERISTICS

DC Characteristics

DC Characteristics Ta = 25°C						Га = 25°С
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds=20V, Vgs= 0V	-	-	10	μA
Gate-Source Leak Current	lgss	Vgs= \pm 8V, Vds= 0V	-	-	±10	μA
Gate-Source Cut-Off Voltage	Vgs(off)	ld= 1mA, Vds= 10V	0.5	-	1.2	V
Drain-Source On-State Resistance *1	Rds(on)	ld= 2A, Vgs= 4.5V	-	0.037	0.050	Ω
		ld= 2A, Vgs= 2.5V	-	0.05	0.07	Ω
		ld= 0.5A, Vgs= 1.5V	-	0.1	0.15	Ω
Forward Transfer Admittance *1	Yfs	ld= 2A, Vds= 10V	-	10	-	S
Body Drain Diode Forward Voltage	Vf	lf= 4A, Vgs= 0V	-	0.85	1.1	V

*1 Effective during pulse test.

Dynamic Characteristics

Dynamic Characteristics Ta = 25°C						a = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= 10V, Vgs=0V f= 1MHz	-	390	-	pF
Output Capacitance	Coss		-	210	-	pF
Feedback Capacitance	Crss		-	90	-	pF

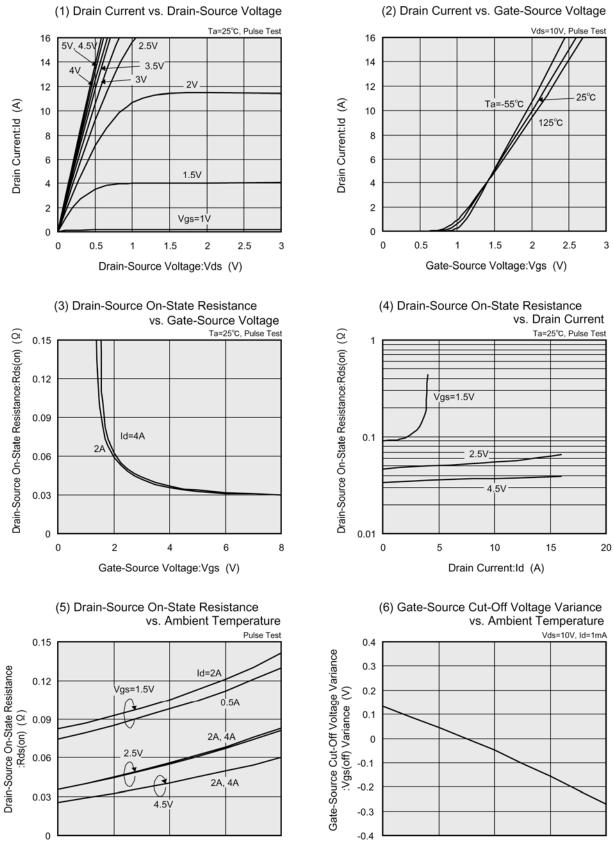
Switching Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= 5V, Id=2A Vdd= 10V	-	10	-	ns
Rise Time	tr		-	15	-	ns
Turn-Off Delay Time	td (off)		-	85	-	ns
Fall Time	tf		-	45	-	ns

Thermal Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	62.5	-	°C/W





-50

0

50

Ambient Temperature:Topr (°C)

100

150

-50

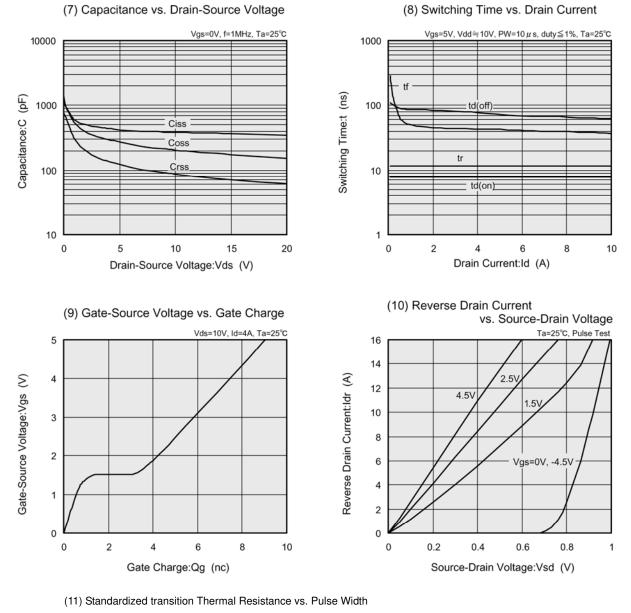
0

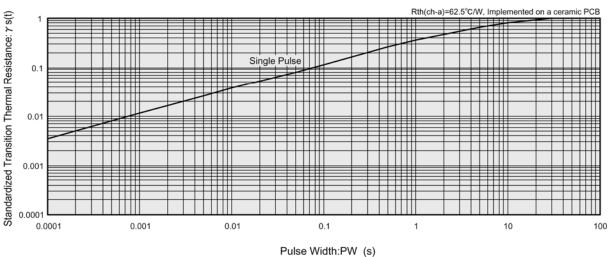
150

50 Ambient Temperature:Topr (°C)

100

■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





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